2SJ275



# **Ultrahigh-Speed Switching Applications**

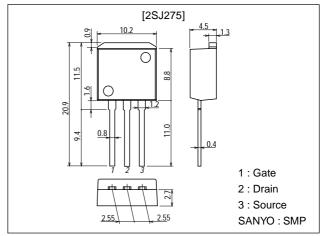
#### **Features**

- · Low ON resistance.
- · Ultrahigh-speed switching.
- · Low-voltage drive.
- · Surface mount type device making the following possible.
  - · Reduction in the number of manufacturing processes for 2SJ275-applied equipment.
- · High density surface mount applications.
- · Small size of 2SJ275-applied equipment.

## **Package Dimensions**

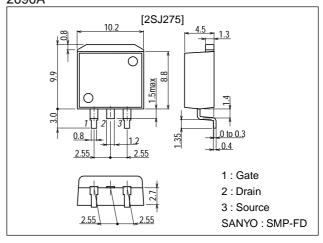
unit:mm

2093A



unit:mm

#### 2090A



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# **Specifications**

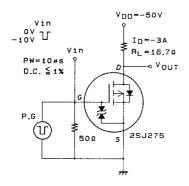
### Absolute Maximum Ratings at Ta = 25°C

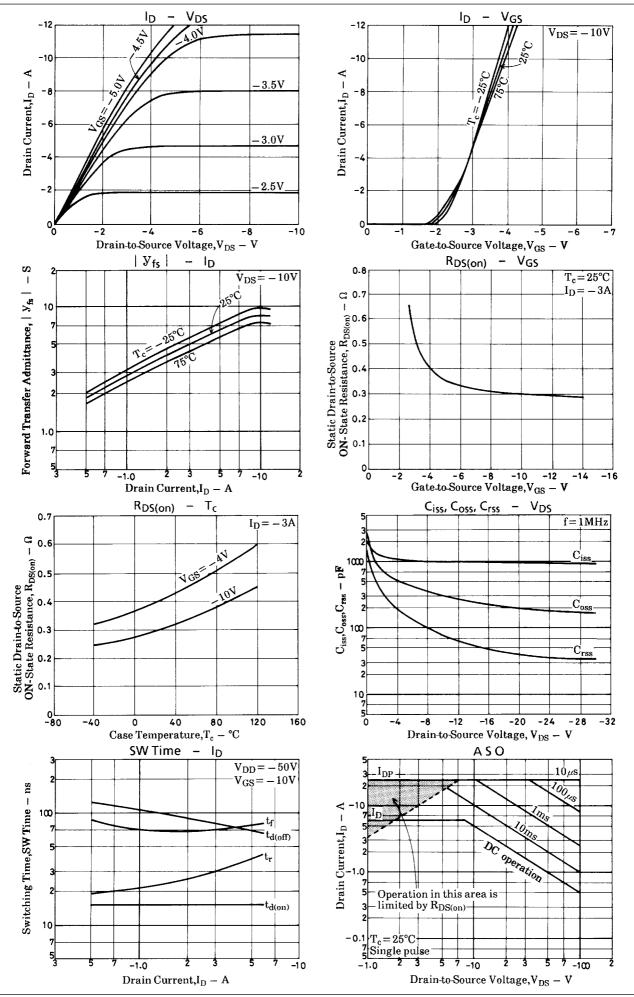
Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V <sub>DSS</sub>		-100	V
Gate-to-Source Voltage	V <sub>GSS</sub>		±15	V
Drain Current (DC)	ID		-6	Α
Drain Current (Pulse)	I <sub>DP</sub>	PW≤10μs, duty cycle≤1%	-24	Α
Allowable Power Dissipation	D_		1.65	W
	P <sub>D</sub>	Tc=25°C	50	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

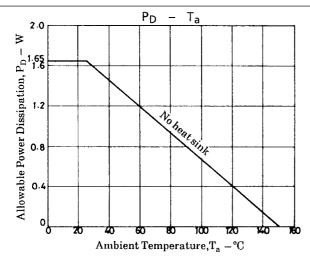
### Electrical Characteristics at Ta = 25°C

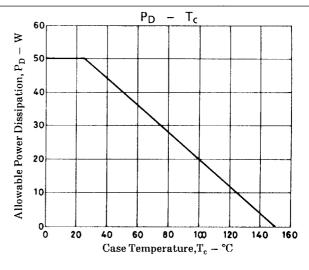
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	I <sub>D</sub> =-1mA, V <sub>GS</sub> =0	-100			V
Gate-to-Source Breakdown Voltage	V <sub>(BR)</sub> GSS	I <sub>G</sub> =±100μA, V <sub>DS</sub> =0	±15			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =-100V, V <sub>GS</sub> =0			-100	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0			±10	μΑ
Cutoff Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> =-10V, I <sub>D</sub> =-1mA	-1.0		-2.0	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> =-10V, I <sub>D</sub> =-3A	3	5		S
Static Drain-to-Source ON-State Resistance	R <sub>DS(on)</sub>	I <sub>D</sub> =-3A, V <sub>GS</sub> =-10V		0.3	0.4	Ω
	R <sub>DS(on)</sub>	I <sub>D</sub> =-3A, V <sub>GS</sub> =-4V		0.4	0.55	Ω
Input Capacitance	Ciss	V <sub>DS</sub> =-20V, f=1MHz		950		pF
Output Capacitance	Coss	V <sub>DS</sub> =-20V, f=1MHz		200		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =-20V, f=1MHz		40		pF
Turn-ON Delay Time	t <sub>d</sub> (on)	See specified Test Circuit		15		ns
Rise Time	t <sub>r</sub>	See specified Test Circuit		30		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit		80		ns
Fall Time	t <sub>f</sub>	See specified Test Circuit		70		ns
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-6A, V <sub>GS</sub> =0		-1.0	-1.5	V

## **Switching Time Test Circuit**









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